Fibrous Dust Testing

Accumulations of dusts have always hampered cooling, to some extent, but dusts and electronics cooling problems of the past usually involved industrial or military applications. To understand why dust has become such a menace, we should first look at the new technologies of heat removal. These technologies have evolved to remove tremendous amounts of heat in small packages. The new designs include everything from close-coupled fans and/or self-contained heat pipes, to recalculating coolant systems using liquid metals. Though quite different in design most have two things in common. They have fine pitched fins to maximize surface area and they require high air flows through the fins.

If you have, any doubts as to the seriousness of this issue just type, "heat sink dust" into your favorite search engine and see what happens. Last time I did, I got 4.4 million hits! The combination of fine pitched fins and high airflows can remove a lot of heat but they also collect a lot of dust! Figures 1, 2, 3 are just a few examples of heat sink contamination you can find on the web.

Clogged Heat Sink Fins



Figure 1: Clogged Heat Sink Fins (Image used with permission (c) 2005 www.overclockers.com)

Laptop Fibrous Dust Clogging



Figure 2: Laptop Fibrous Dust Clogging (Image used with permission (c) 2005 www.short-media.com)

Desktop Heat Sink Clogging

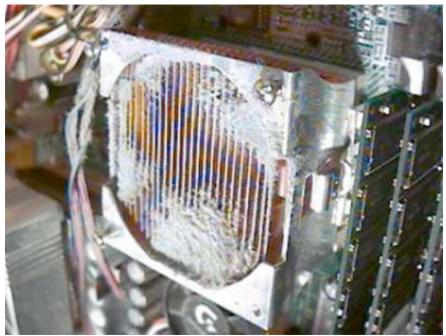


Figure 3: Desktop Heat Sink Clogging (Image used with permission (c) 2005 www.short-media.com)

Standard Tests

Like most test labs, we try to use standard tests methods whenever possible. Our client was looking for a test to duplicate field dust problems in laptop computers. We recommended settling dust testing similar to IEC-60068-2-681 and MIL-STD-810F2. The only modification to these methods was to increase the concentrations of injected dust because a highly accelerated test was required. However, these tests proved inadequate in duplicating timely failures even at grossly unrealistic test levels. Failure Mechanism

Further information from analysis of the failure dust clogs reveals the reasons. Fiber is all-important! The test media must contain a similar variety of fiber lengths and smaller particles to duplicate the clogging action to facilitate failures. The longer fibers bridge the leading edge of fine pitched fins building a mat of tangled fiber. The reduced airflow causes the processor temperature to increase which in turn causes the fans to increase in speed. More air flow keeps the processor cool but brings in more contaminates. The longer fibers soon block the airways to the point where smaller fibers and dusts begin to collect on the fiber mat. The contamination buildup escalates to the point where virtually no air can pass. The product now has serious thermal problems. At room temperature, it will generally self protect shut down but damage from excessive temperatures is always a possibility.

Problem

I would love to say I had an answer to fibrous dust contamination problems, but that is not what I do. I am just a test guy trying to answer another daunting question. How can I test the immunity of a solution or the susceptibility of new a design? There seems to be no good answer, all dust test equipment and methods used fine particles and powders. The tests in general were designed to test products with air filters. In consumer products, where "filter" is a dirty word, there is a whole range of contaminates these tests do not address. Existing test methods and equipment cannot duplicate the fibrous dust failure mechanism nor can they be adapted to disburse fibrous dust mixtures. Without equipment and methods to duplicate a problem, effective testing of a solution is nearly impossible!

Dust Test Media

It started with my search for fibrous dust test media; I got many helpful suggestions from my colleges. Most involved cleaning their houses or changing their vacuum cleaner bags. Actually years ago I was part of an experiment that used vacuum cleaner dust as a test media. The experience had left a bad taste in my mouth, literally. The obvious consistency and repeatability issues of using natural dusts is so formidable, formulating a synthetic dust media is the only real choice. Environmental dust contaminations contain fibers and particles from a near infinite number of sources. The percentages of each ingredient in a synthetic dust should mimic the general physical size properties of actual field return heat sink contaminations. However, getting a variety of cut fiber and

mixing with standard test dusts components created a tangled clumpy mess that at first seems impossible to disburse in any controlled fashion. (See Figure 4.) I stared at the first batch like a cat that had just coughed up a giant hairball, wondering what to do next. Nothing I had ever seen could disperse such a mess and I had to make it happen.

Pre-injected dust mixture



Figure 4: Pre-injected dust mixture

Fibrous Dust generator

Previous testing with non-standard dusts held part of the answer. A system of air randomizers I had used to propel large lightweight particles in a special application dust test was a good start. The randomizer design was incorporated in a chambered system combined with a high volume jet pump. The first prototype worked better than I dreamed possible! It is totally powered with compressed air. It has no moving parts to jam or clog and can function well in the worse dust environments I have ever seen. Within a couple of weeks, we were reproducing field failures in as little as two hours of test time. Figure 5 is a simplified drawing of the dust generator and Figure 6 demonstrates the generators effectiveness.

Cycloclastic Dust Generator

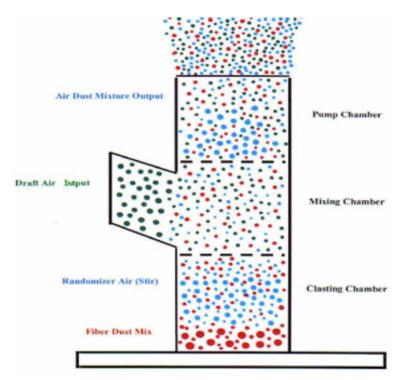


Figure 5: Cycloclastic Dust Generator

Settled Dust, Chamber Floor 16 Hour Accumulation



Figure 6: Settled Dust, Chamber Floor 16 Hour Accumulation

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Acceleration Pains

Accelerated testing with fibrous dust produced issues not seen in standardized dust testing, even at equally accelerated levels. The first problem had to do with air inlet clogging. While inlet clogging can be a design concern for stationary products, it is less problematic for portable equipment. Portable equipment such as laptop computers are likely to have input air vents cleared of dust accumulations through handling and normal use. In addition to frequent handling, the user of portable equipment might actually see these accumulations and periodically clean the inlet vents.

In accelerated testing, fibers tend to form a natural filter on the inlets before heat sink clogging can occur. This action causes only very small particles to reach the heat sink and stops the fiber failure mechanism from occurring. To facilitate normal use actions and allow heat sink clogging to occur, periodic clearing of input vents is a test method necessity. (I thought I could just start it up and comeback at the end of the day. Wrong!) Likewise, it is unlikely a two-year blanket of dust accumulation will ever be present on the surface of a laptop in use. (Except for maybe in my teenaged sons room) The periodic clearing of dust buildup stops an unrealistic thermal blanket from forming that could disrupt radiant heat dissipation or block topside air vents.

16-Hour Dust Accumulation



Figure 7: 16-Hour Dust Accumulation

Ingress Modes in Laptops

With periodic inlet cleaning, the settling dust test method can duplicate the fiber clogging failure mechanisms in portable computer heat sinks. However, even with inlet cleaning the heat sink accumulations tended to contain higher concentrations of fine particle dusts and lower fiber content than desired to correlate to field data. While it may seem logical to assume the synthetic dust mixture requires adjustment (i.e. reduce the fine particle dusts vs. fiber), we must first look at how dust enters these systems.

A laptop's portable nature solicits two major modes of dust ingress:

- 1. One mode is from active (airborne dust),
- 2. The second is from passive dusts previously settled on surfaces or from direct contact with dust producing materials.

Early experiments in passive only dust testing, resulted in an opposite results of active only, with high fiber content clogging of heatsinks and relatively low concentrations of smaller dust. The bottom facing fan inlet creates airflows that tend to vacuum up fibrous dusts leaving finer dusts behind. An adjustment made to the dust mixture in active testing resulting in accumulations close to field compositions would still seem an effective test method. Test experiments prove this method worked quite well as long as all laptop designs remain the same. However, any design with only top or side air inlets could eliminate most passive modes of ingress. Because passive (settled) dust concentrates on surfaces, such a system could prove to be more robust in actual use, yet it would be at a distinct disadvantage in an active (settling) mode only test. It is apparent that any realistic evaluation of future portable system designs must include both active and passive modes of dust ingress. Figures 8, 9, 10 demonstrate the differences in accumulation composition using active, passive and the combined active/passive test methods.

Passive Only Dust Test Accumulation



Figure 8: Passive Only Dust Test Accumulation

Active Only Dust Test Accumulation



Figure 9: Active Only Dust Test Accumulation

Combination Active/Passive Dust Test



Figure 10: Combination Active/Passive Dust Test

Passive test experiments were extremely labor-intensive requiring moving the test units every 10 minutes to a new pre-dusted location. The process also required once per hour removing the units, cleaning the test accumulation surface, and recoating with dust. Being the guy that has to run this test, I was VERY motivated to design a prototyperotating fixture table to simulate both modes of dust ingress. The table design also facilitated bottom air inlet cleaning with rotating brushes at 10-minute intervals. This

brush action reduces problems with inlet clogging and simulated direct contact passive dust ingress from clothing, carpet, etc. The periodic table rotation also produced a significant benefit in dust uniformity. Achieving uniformity location to location within a settling dust test chamber is always difficult. A requirement to test multiple units simultaneously brought this issue more attention. The periodic rotation of this design caused each unit to travel to all possible locations therefore; they will all see the same average level of dust over time. As expected, the prototype fixture produced accumulation results very similar to field returns.

DT-550 Dust Test Chamber

To accommodate multiple samples, and larger laptop computers with a combination active/passive mode test table, a larger chamber was required. The thermal nature of failures also requires heating and cooling control. The system must provide a stable temperature environment with changing thermal load handling capability. Low humidity maintained within the operating temperature range of a variety of product types is also essential. The DT-550 test system design (Figure 11) satisfies these test requirements. The chamber can accommodate the AP-550 rotating combined active/passive test fixture that is large enough for four portable computers with up to 21" screens. The system can also facilitate testing of desktop and server products as well as most products where fibrous dust contamination is a concern. I must add these test systems are now marketed by Compatibility Products Corporation.

Dust Test Chamber



Dust Test Chamber Accommodates Active/Passive Testing

Acceleration Rates

Information on acceleration rates from existing standards provided some rough guidelines to calculate acceleration rates. Using the existing guidelines, the acceleration variance is very large, based on product use location. As an example, in MIL-STD-810F the worstcase industrial location can be 200 times that of the best-case rural location. We spent a lot of time working on calculated rates but there are so many variables it is difficult to gauge accuracy. Measured acceleration rates of products with known time to failure in field use, have demonstrated the rates to be around 45 days per test hour or approximately 2 years in a 16-hour test. Because these demonstrated rates are based on early field failures, they must be considered worst-case location based. Equipment with higher or lower usage rates and/or restricted locations will differ. As with any type of accelerated testing, acceleration factor predictions tied closest to field data are always the most reliable.

CONCLUSIONS

Full details of the testing performed to date, remain client confidential. However, over 70 tests on dozens of designs have produced a stable repeatable test process. A significant number of the products tested had known field performance histories, and the test results correlate with those histories. Products with no history of dust related issues generally do well in fibrous dust testing, while those with histories of dust complications have problems.

With ever increasing semiconductor performance, the demand for high efficiency cooling systems will continue to progress. The effects of fibrous dusts on these systems will be critical. Industry standard test methods and criteria for fibrous dust testing do not exist at this time. However, the methods and equipment described in this paper have proven to be effective at producing realistic results. Even if test standards are developed, manufactures will still have to assess risk based on individual product dust evaluations and best engineering judgment.

Accelerated testing early in the design process is always a good idea regardless of the type of environmental stimuli applied. Testing for heat sink/system immunity to fibrous dust contaminates is a crucial step in identifying problems and assessing risk. While there appears to be no easy solutions to fibrous dust contamination issues, testing services and equipment are now available to analyze designs for fibrous dust susceptibility. An accurate test to reproduce a problem is always the first step on the road to successful solutions. Those that choose to test for these problems early will advance, those that choose to ignore them will be "left in the dust".